



Material Content Data Sheet



Halogen-Free

Sales Product Name	2ED21824S06J	Issued	08. April 2022
MA#	MA005583774		
Package	PG-DSO-14-70	Weight*	138.51 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.081	1.50	1.50	15024	15024
leadframe	inorganic material	phosphorus	7723-14-0	0.014	0.01		104	
	non noble metal	zinc	7440-66-6	0.057	0.04		415	
	non noble metal	iron	7439-89-6	1.150	0.83		8299	
	non noble metal	copper	7440-50-8	46.675	33.70	34.58	336981	345799
wires	noble metal	palladium	7440-05-3	0.000			4	
	non noble metal	copper	7440-50-8	0.049	0.04	0.04	352	356
encapsulation	organic material	carbon black	1333-86-4	0.344	0.25		2487	
	plastics	epoxy resin	-	12.487	9.02		90156	
	inorganic material	silicondioxide	60676-86-0	73.288	52.90	62.17	529127	621770
leadfinish	non noble metal	tin	7440-31-5	1.226	0.89	0.89	8852	8852
plating	noble metal	silver	7440-22-4	0.307	0.22	0.22	2213	2213
glue	plastics	acrylic resin	-	0.182	0.13		1317	
	noble metal	silver	7440-22-4	0.647	0.47	0.60	4669	5986
*deviation	< 10%	Sum in total:				100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption.

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